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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	31
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	20K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 10x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-LQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101fjdfp-50">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101fjdfp-50</a>

Table 1-1. List of Ordering Part Numbers

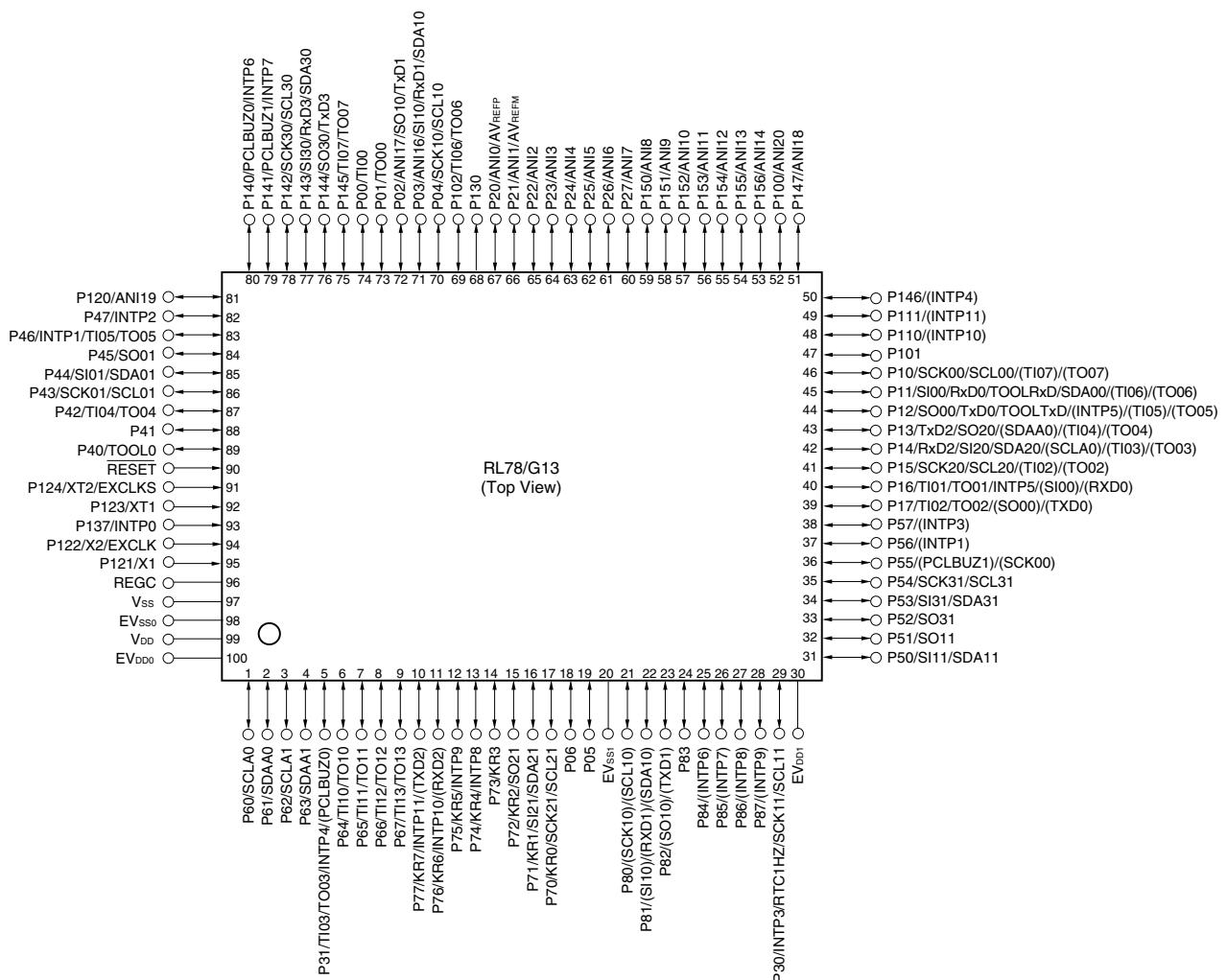
(2/12)

Pin count	Package	Data flash	Fields of Application <small>Note</small>	Ordering Part Number
25 pins	25-pin plastic WFLGA (3 × 3 mm, 0.5 mm pitch)	Mounted	A	R5F1008AALA#U0, R5F1008CALA#U0, R5F1008DALA#U0, R5F1008EALA#U0 R5F1008AALA#W0, R5F1008CALA#W0, R5F1008DALA#W0, R5F1008EALA#W0 R5F1008AGLA#U0, R5F1008CGLA#U0, R5F1008DGLA#U0, R5F1008EGLA#U0 R5F1008AGLA#W0, R5F1008CGLA#W0, R5F1008DGLA#W0, R5F1008EGLA#W0
			G	R5F1018AALA#U0, R5F1018CALA#U0, R5F1018DALA#U0, R5F1018EALA#U0 R5F1018AALA#W0, R5F1018CALA#W0, R5F1018DALA#W0, R5F1018EALA#W0
30 pins	30-pin plastic LSSOP (7.62 mm (300), 0.65 mm pitch)	Mounted	A	R5F100AAASP#V0, R5F100ACASP#V0, R5F100ADASP#V0, R5F100AEASP#V0, R5F100AFASP#V0, R5F100AGASP#V0 R5F100AAASP#X0, R5F100ACASP#X0, R5F100ADASP#X0 R5F100AEASP#X0, R5F100AFASP#X0, R5F100AGASP#X0 R5F100AADSP#V0, R5F100ACDSP#V0, R5F100ADDSP#V0, R5F100AEDSP#V0, R5F100AFDSP#V0, R5F100AGDSP#V0 R5F100AADSP#X0, R5F100ACDSP#X0, R5F100ADDSP#X0, R5F100AEDSP#X0, R5F100AFDSP#X0, R5F100AGDSP#X0 R5F100AAGSP#V0, R5F100ACGSP#V0, R5F100ADGSP#V0, R5F100AEGSP#V0, R5F100AFGSP#V0, R5F100AGGSP#V0 R5F100AAGSP#X0, R5F100ACGSP#X0, R5F100ADGSP#X0, R5F100AEGSP#X0, R5F100AFGSP#X0, R5F100AGGSP#X0
			D	R5F101AAASP#V0, R5F101ACASP#V0, R5F101ADASP#V0, R5F101AEASP#V0, R5F101AFASP#V0, R5F101AGASP#V0 R5F101AAASP#X0, R5F101ACASP#X0, R5F101ADASP#X0, R5F101AEASP#X0, R5F101AFASP#X0, R5F101AGASP#X0 R5F101AADSP#V0, R5F101ACDSP#V0, R5F101ADDSP#V0, R5F101AEDSP#V0, R5F101AFDSP#V0, R5F101AGDSP#V0 R5F101AADSP#X0, R5F101ACDSP#X0, R5F101ADDSP#X0, R5F101AEDSP#X0, R5F101AFDSP#X0, R5F101AGDSP#X0
32 pins	32-pin plastic HWQFN (5 × 5 mm, 0.5 mm pitch)	Mounted	A	R5F100BAANA#U0, R5F100BCANA#U0, R5F100BDANA#U0, R5F100BEANA#U0, R5F100BFANA#U0, R5F100BGANA#U0 R5F100BAANA#W0, R5F100BCANA#W0, R5F100BDANA#W0, R5F100BEANA#W0, R5F100BFANA#W0, R5F100BGANA#W0 R5F100BADNA#U0, R5F100BCDNA#U0, R5F100BDDNA#U0, R5F100BEDNA#U0, R5F100BFDNA#U0, R5F100BGDNA#U0 R5F100BADNA#W0, R5F100BCDNA#W0, R5F100BDDNA#W0, R5F100BEDNA#W0, R5F100BFDNA#W0, R5F100BGDNA#W0 R5F100BAGNA#U0, R5F100BCGNA#U0, R5F100BDGNA#U0, R5F100BEGNA#U0, R5F100BFGNA#U0, R5F100BGGNA#U0 R5F100BAGNA#W0, R5F100BCGNA#W0, R5F100BDGNA#W0, R5F100BEGNA#W0, R5F100BFGNA#W0, R5F100BGGNA#W0
			D	R5F101BAANA#U0, R5F101BCANA#U0, R5F101BDANA#U0, R5F101BEANA#U0, R5F101BFANA#U0, R5F101BGANA#U0 R5F101BAANA#W0, R5F101BCANA#W0, R5F101BDANA#W0, R5F101BEANA#W0, R5F101BFANA#W0, R5F101BGANA#W0 R5F101BADNA#U0, R5F101BCDNA#U0, R5F101BDDNA#U0, R5F101BEDNA#U0, R5F101BFDNA#U0, R5F101BGDNA#U0 R5F101BADNA#W0, R5F101BCDNA#W0, R5F101BDDNA#W0, R5F101BEDNA#W0, R5F101BFDNA#W0, R5F101BGDNA#W0
		Not mounted	A	R5F101BAANA#U0, R5F101BCANA#U0, R5F101BDANA#U0, R5F101BEANA#U0, R5F101BFANA#U0, R5F101BGANA#U0 R5F101BAANA#W0, R5F101BCANA#W0, R5F101BDANA#W0, R5F101BEANA#W0, R5F101BFANA#W0, R5F101BGANA#W0 R5F101BADNA#U0, R5F101BCDNA#U0, R5F101BDDNA#U0, R5F101BEDNA#U0, R5F101BFDNA#U0, R5F101BGDNA#U0 R5F101BADNA#W0, R5F101BCDNA#W0, R5F101BDDNA#W0, R5F101BEDNA#W0, R5F101BFDNA#W0, R5F101BGDNA#W0
			D	R5F101BAANA#U0, R5F101BCANA#U0, R5F101BDANA#U0, R5F101BEANA#U0, R5F101BFANA#U0, R5F101BGANA#U0 R5F101BAANA#W0, R5F101BCANA#W0, R5F101BDANA#W0, R5F101BEANA#W0, R5F101BFANA#W0, R5F101BGANA#W0 R5F101BADNA#U0, R5F101BCDNA#U0, R5F101BDDNA#U0, R5F101BEDNA#U0, R5F101BFDNA#U0, R5F101BGDNA#U0 R5F101BADNA#W0, R5F101BCDNA#W0, R5F101BDDNA#W0, R5F101BEDNA#W0, R5F101BFDNA#W0, R5F101BGDNA#W0

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

- 100-pin plastic LQFP (14 × 20 mm, 0.65 mm pitch)



**Cautions** 1. Make EV<sub>SS0</sub>, EV<sub>SS1</sub> pins the same potential as V<sub>SS</sub> pin.

2. Make V<sub>DD</sub> pin the potential that is higher than EV<sub>DD0</sub>, EV<sub>DD1</sub> pins (EV<sub>DD0</sub> = EV<sub>DD1</sub>).
3. Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks** 1. For pin identification, see **1.4 Pin Identification**.

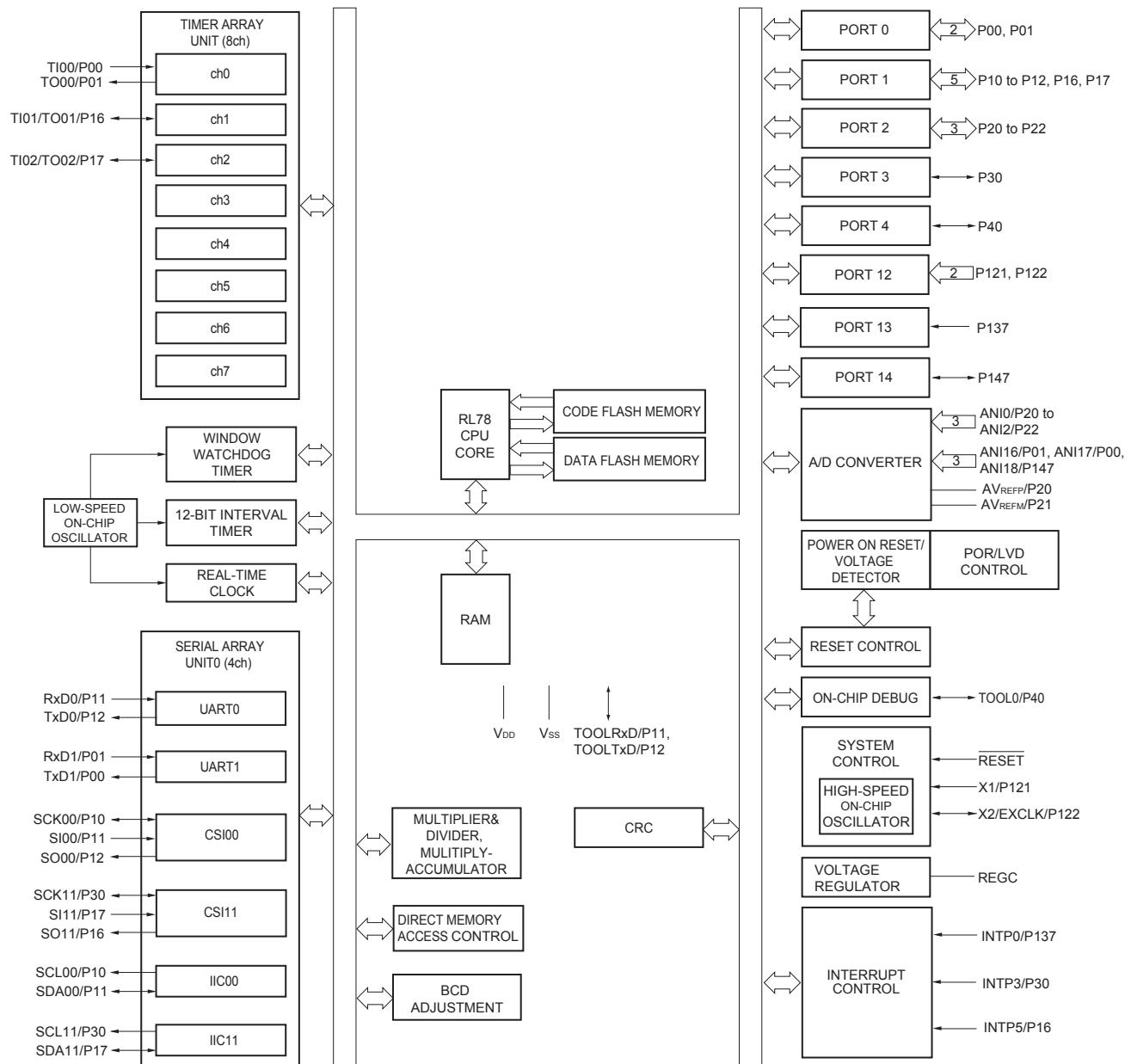
2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub>, EV<sub>DD0</sub> and EV<sub>DD1</sub> pins and connect the V<sub>SS</sub>, EV<sub>SS0</sub> and EV<sub>SS1</sub> pins to separate ground lines.
3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.4 Pin Identification

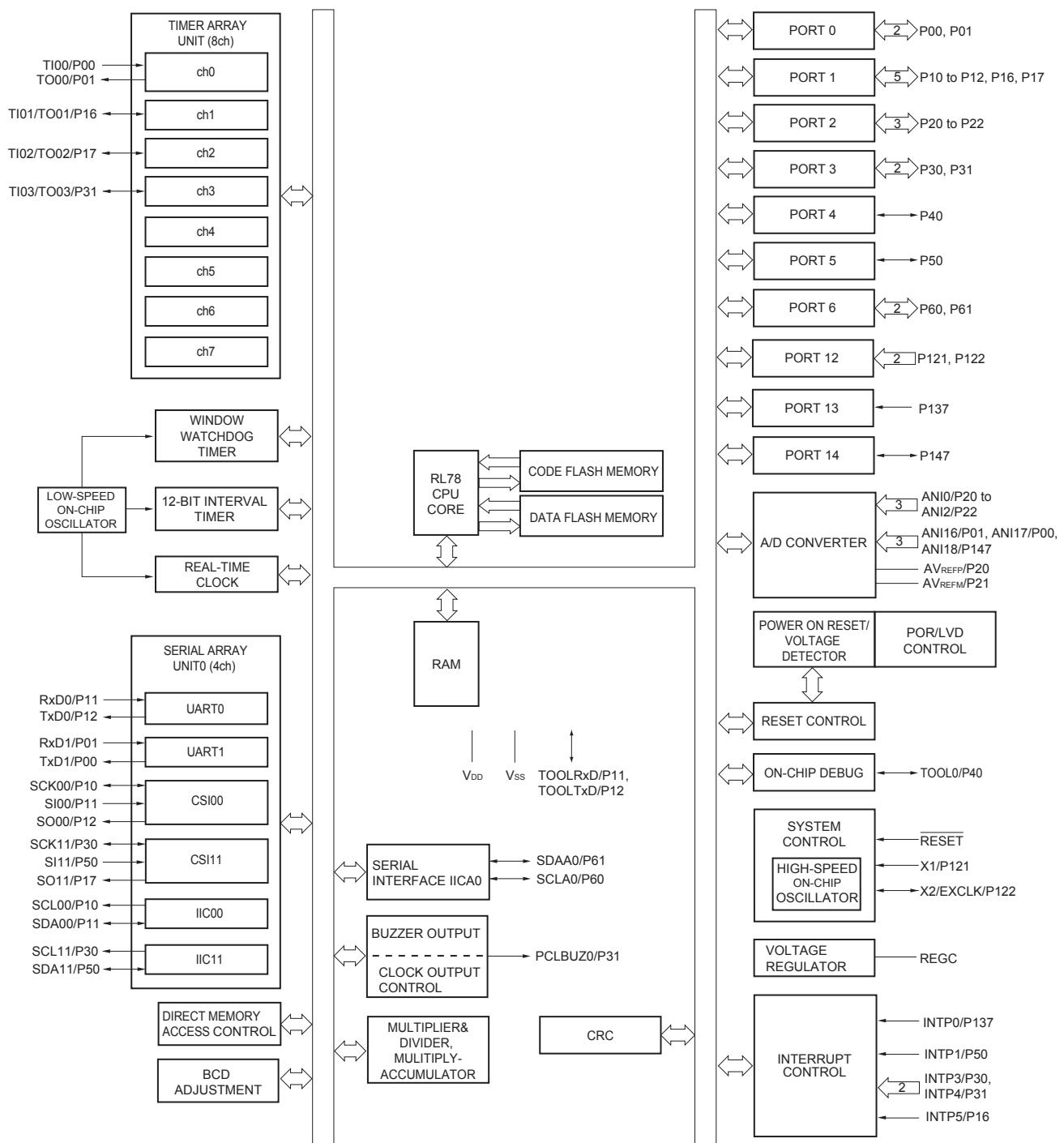
AN10 to AN14,		REGC:	Regulator capacitance
AN16 to ANI26:	Analog input	RESET:	Reset
AV <sub>REFM</sub> :	A/D converter reference potential (– side) input	RTC1HZ:	Real-time clock correction clock (1 Hz) output
AV <sub>REFP</sub> :	A/D converter reference potential (+ side) input	RxD0 to RxD3:	Receive data
EV <sub>VDD0</sub> , EV <sub>VDD1</sub> :	Power supply for port	SCK00, SCK01, SCK10, SCK11, SCK20, SCK21,	
EV <sub>SS0</sub> , EV <sub>SS1</sub> :	Ground for port	SCLA0, SCLA1:	Serial clock input/output
EXCLK:	External clock input (Main system clock)	SCLA0, SCLA1, SCL00, SCL01, SCL10, SCL11,	
EXCLKS:	External clock input (Subsystem clock)	SCL20, SCL21, SCL30, SCL31:	Serial clock output
INTP0 to INTP11:	Interrupt request from peripheral	SDAA0, SDAA1, SDA00, SDA01, SDA10, SDA11,	
KR0 to KR7:	Key return	SDA20, SDA21, SDA30, SDA31:	Serial data input/output
P00 to P07:	Port 0	SI00, SI01, SI10, SI11,	
P10 to P17:	Port 1	SI20, SI21, SI30, SI31:	Serial data input
P20 to P27:	Port 2	SO00, SO01, SO10,	
P30 to P37:	Port 3	SO11, SO20, SO21,	
P40 to P47:	Port 4	SO30, SO31:	Serial data output
P50 to P57:	Port 5	TI00 to TI07,	
P60 to P67:	Port 6	TI10 to TI17:	Timer input
P70 to P77:	Port 7	TO00 to TO07,	
P80 to P87:	Port 8	TO10 to TO17:	Timer output
P90 to P97:	Port 9	TOOL0:	Data input/output for tool
P100 to P106:	Port 10	TOOLRxD, TOOLTxD:	Data input/output for external device
P110 to P117:	Port 11	TxD0 to TxD3:	Transmit data
P120 to P127:	Port 12	V <sub>DD</sub> :	Power supply
P130, P137:	Port 13	V <sub>SS</sub> :	Ground
P140 to P147:	Port 14	X1, X2:	Crystal oscillator (main system clock)
P150 to P156:	Port 15	XT1, XT2:	Crystal oscillator (subsystem clock)
PCLBUZ0, PCLBUZ1:	Programmable clock output/buzzer output		

## 1.5 Block Diagram

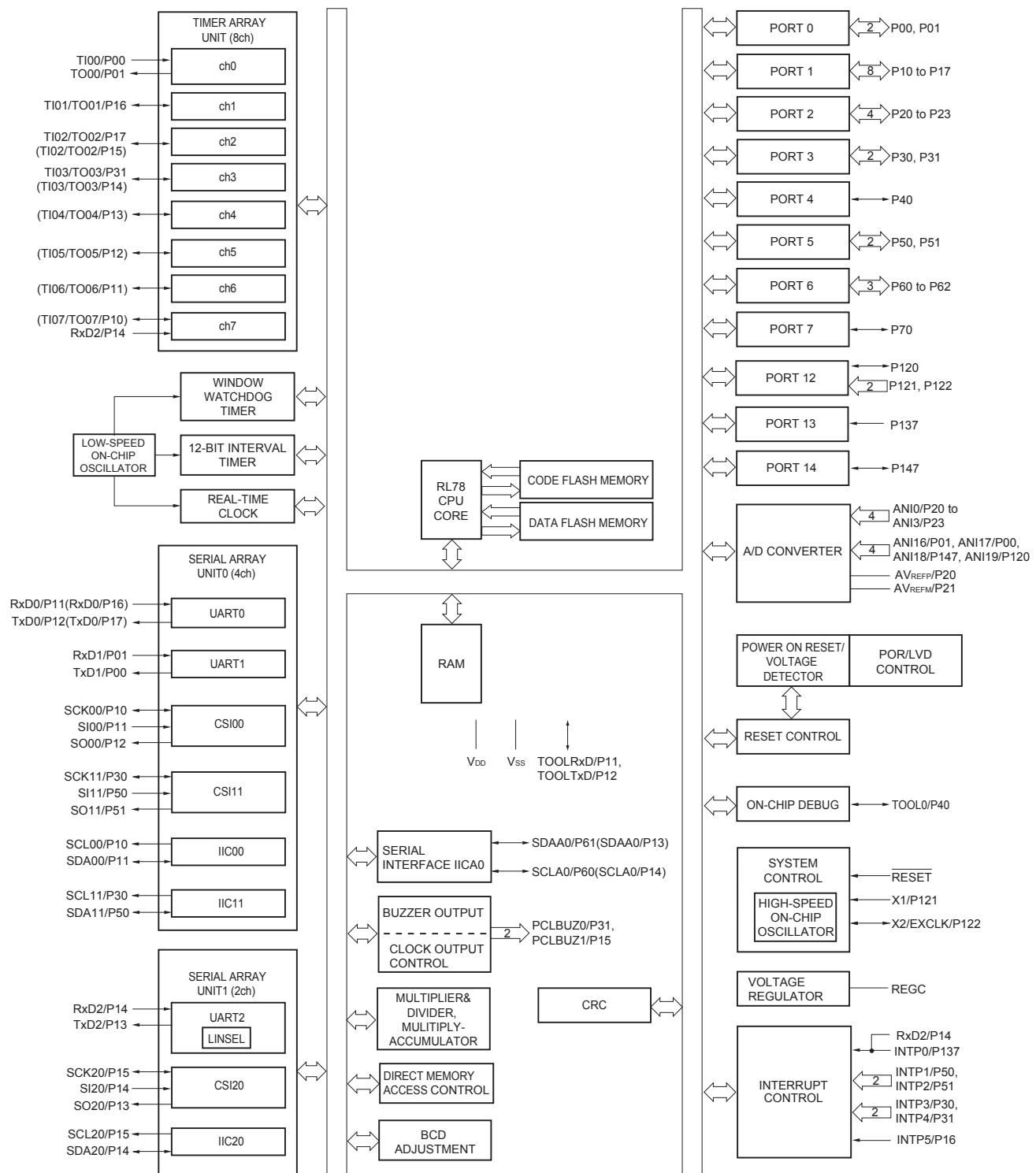
### 1.5.1 20-pin products



## 1.5.2 24-pin products

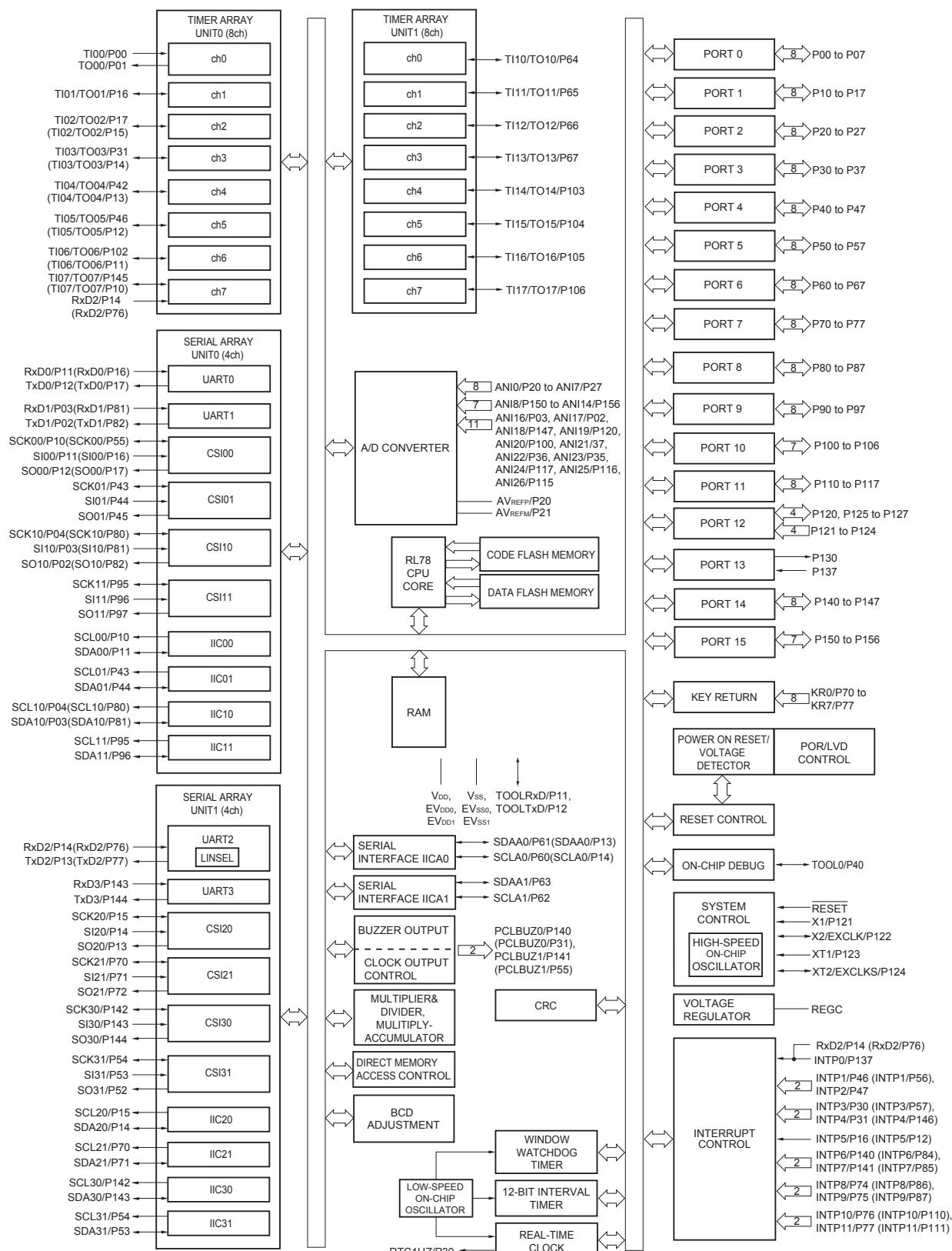


## 1.5.5 32-pin products



**Remark** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.5.14 128-pin products



**Remark** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

- Notes**
1. Total current flowing into  $V_{DD}$ ,  $EV_{DD0}$ , and  $EV_{DD1}$ , including the input leakage current flowing when the level of the input pin is fixed to  $V_{DD}$ ,  $EV_{DD0}$ , and  $EV_{DD1}$ , or  $V_{SS}$ ,  $EV_{SS0}$ , and  $EV_{SS1}$ . The values below the MAX. column include the peripheral operation current . However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  2. During HALT instruction execution by flash memory.
  3. When high-speed on-chip oscillator and subsystem clock are stopped.
  4. When high-speed system clock and subsystem clock are stopped.
  5. When high-speed on-chip oscillator and high-speed system clock are stopped. When  $RTCLPC = 1$  and setting ultra-low current consumption ( $AMPHS1 = 1$ ). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 

HS (high-speed main) mode:	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ @ 1 MHz to 32 MHz
	$2.4 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ @ 1 MHz to 16 MHz
LS (low-speed main) mode:	$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ @ 1 MHz to 8 MHz
	LV (low-voltage main) mode: $1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ @ 1 MHz to 4 MHz
  8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.

- Remarks**
1.  $f_{MX}$ : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  2.  $f_{IH}$ : High-speed on-chip oscillator clock frequency
  3.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)
  4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$

## 2.4 AC Characteristics

**( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ )**

Items	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum instruction execution time)	TCY	Main system clock ( $f_{MAIN}$ ) operation	HS (high-speed main) mode	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.03125		1	$\mu\text{s}$
				$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$	0.0625		1	$\mu\text{s}$
			LS (low-speed main) mode	$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.125		1	$\mu\text{s}$
			LV (low-voltage main) mode	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.25		1	$\mu\text{s}$
		Subsystem clock ( $f_{SUB}$ ) operation		$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	28.5	30.5	31.3	$\mu\text{s}$
		In the self programming mode	HS (high-speed main) mode	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.03125		1	$\mu\text{s}$
				$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$	0.0625		1	$\mu\text{s}$
			LS (low-speed main) mode	$1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.125		1	$\mu\text{s}$
			LV (low-voltage main) mode	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	0.25		1	$\mu\text{s}$
External system clock frequency	f <sub>EX</sub>	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$			1.0		20.0	MHz
		$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$			1.0		16.0	MHz
		$1.8 \text{ V} \leq V_{DD} < 2.4 \text{ V}$			1.0		8.0	MHz
		$1.6 \text{ V} \leq V_{DD} < 1.8 \text{ V}$			1.0		4.0	MHz
	f <sub>EXS</sub>				32		35	kHz
External system clock input high-level width, low-level width	t <sub>EXH</sub> , t <sub>EXL</sub>	$2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$			24			ns
		$2.4 \text{ V} \leq V_{DD} < 2.7 \text{ V}$			30			ns
		$1.8 \text{ V} \leq V_{DD} < 2.4 \text{ V}$			60			ns
		$1.6 \text{ V} \leq V_{DD} < 1.8 \text{ V}$			120			ns
	t <sub>EXHS</sub> , t <sub>EXLS</sub>				13.7			$\mu\text{s}$
TI00 to TI07, TI10 to TI17 input high-level width, low-level width	t <sub>TIH</sub> , t <sub>TIIL</sub>				1/f <sub>MCK</sub> +10			ns <sup>Note</sup>
TO00 to TO07, TO10 to TO17 output frequency	f <sub>TO</sub>	HS (high-speed main) mode	4.0 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				16	MHz
			2.7 V $\leq EV_{DD0} < 4.0 \text{ V}$				8	MHz
			1.8 V $\leq EV_{DD0} < 2.7 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LS (low-speed main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LV (low-voltage main) mode	1.6 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				2	MHz
		HS (high-speed main) mode	4.0 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				16	MHz
			2.7 V $\leq EV_{DD0} < 4.0 \text{ V}$				8	MHz
			1.8 V $\leq EV_{DD0} < 2.7 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
PCLBUZ0, PCLBUZ1 output frequency	f <sub>PCL</sub>	LS (low-speed main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
			1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
		LV (low-voltage main) mode	1.8 V $\leq EV_{DD0} \leq 5.5 \text{ V}$				4	MHz
			1.6 V $\leq EV_{DD0} < 1.8 \text{ V}$				2	MHz
Interrupt input high-level width, low-level width	t <sub>INTH</sub> , t <sub>INTL</sub>	INTP0	$1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$	1				$\mu\text{s}$
		INTP1 to INTP11	$1.6 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	1				$\mu\text{s}$
Key interrupt input low-level width	t <sub>KR</sub>	KR0 to KR7	$1.8 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	250				ns
			$1.6 \text{ V} \leq EV_{DD0} < 1.8 \text{ V}$	1				$\mu\text{s}$
RESET low-level width	t <sub>RSIL</sub>				10			$\mu\text{s}$

(Note and Remark are listed on the next page.)

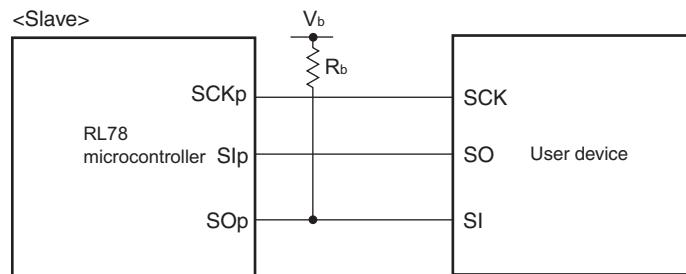
- Remarks 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3),  
g: PIM and POM numbers (g = 0, 1, 4, 5, 8, 14)
- 2.** fMCK: Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

**(4) During communication at same potential (CSI mode) (slave mode, SCKp... external clock input) (1/2)**

(TA = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time <small>Note 5</small>	t <sub>KCY2</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	20 MHz < f <sub>MCK</sub>	8/f <sub>MCK</sub>	—	—	—	—	—	ns
			f <sub>MCK</sub> ≤ 20 MHz	6/f <sub>MCK</sub>	—	6/f <sub>MCK</sub>	—	6/f <sub>MCK</sub>	—	ns
		2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	16 MHz < f <sub>MCK</sub>	8/f <sub>MCK</sub>	—	—	—	—	—	ns
			f <sub>MCK</sub> ≤ 16 MHz	6/f <sub>MCK</sub>	—	6/f <sub>MCK</sub>	—	6/f <sub>MCK</sub>	—	ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		6/f <sub>MCK</sub> and 500	—	6/f <sub>MCK</sub> and 500	—	6/f <sub>MCK</sub> and 500	—	ns
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		6/f <sub>MCK</sub> and 750	—	6/f <sub>MCK</sub> and 750	—	6/f <sub>MCK</sub> and 750	—	ns
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		6/f <sub>MCK</sub> and 1500	—	6/f <sub>MCK</sub> and 1500	—	6/f <sub>MCK</sub> and 1500	—	ns
SCKp high-/low-level width		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		—	—	6/f <sub>MCK</sub> and 1500	—	6/f <sub>MCK</sub> and 1500	—	ns
	t <sub>KL2</sub> , t <sub>KH2</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY2</sub> /2 – 7	—	t <sub>KCY2</sub> /2 – 7	—	t <sub>KCY2</sub> /2 – 7	—	ns
		2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY2</sub> /2 – 8	—	t <sub>KCY2</sub> /2 – 8	—	t <sub>KCY2</sub> /2 – 8	—	ns
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY2</sub> /2 – 18	—	t <sub>KCY2</sub> /2 – 18	—	t <sub>KCY2</sub> /2 – 18	—	ns
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY2</sub> /2 – 66	—	t <sub>KCY2</sub> /2 – 66	—	t <sub>KCY2</sub> /2 – 66	—	ns
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		—	—	t <sub>KCY2</sub> /2 – 66	—	t <sub>KCY2</sub> /2 – 66	—	ns

(Notes, Caution, and Remarks are listed on the next page.)

**CSI mode connection diagram (during communication at different potential)**

- Remarks**
1.  $R_b[\Omega]$ : Communication line (SO<sub>p</sub>) pull-up resistance,  $C_b[F]$ : Communication line (SO<sub>p</sub>) load capacitance,  $V_b[V]$ : Communication line voltage
  2. p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)
  3. fmck: Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  
m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13))
  4. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential.  
Use other CSI for communication at different potential.

- Notes**
- 1. The first clock pulse is generated after this period when the start/restart condition is detected.
  - <R> 2. The maximum value (MAX.) of  $t_{HD:DAT}$  is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

**Caution** The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics ( $I_{OH1}$ ,  $I_{OL1}$ ,  $V_{OH1}$ ,  $V_{OL1}$ ) must satisfy the values in the redirect destination.

**Remark** The maximum value of  $C_b$  (communication line capacitance) and the value of  $R_b$  (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode:  $C_b = 400 \text{ pF}$ ,  $R_b = 2.7 \text{ k}\Omega$

**Notes** 1. Excludes quantization error ( $\pm 1/2$  LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. When  $AV_{REFP} < V_{DD}$ , the MAX. values are as follows.

Overall error: Add  $\pm 1.0$  LSB to the MAX. value when  $AV_{REFP} = V_{DD}$ .

Zero-scale error/Full-scale error: Add  $\pm 0.05\%$ FSR to the MAX. value when  $AV_{REFP} = V_{DD}$ .

Integral linearity error/ Differential linearity error: Add  $\pm 0.5$  LSB to the MAX. value when  $AV_{REFP} = V_{DD}$ .

4. Values when the conversion time is set to 57  $\mu\text{s}$  (min.) and 95  $\mu\text{s}$  (max.).

5. Refer to **2.6.2 Temperature sensor/internal reference voltage characteristics**.

**Remark** The electrical characteristics of the products G: Industrial applications ( $T_A = -40$  to  $+105^\circ\text{C}$ ) are different from those of the products "A: Consumer applications, and D: Industrial applications". For details, refer to **3.1 to 3.10**.

### 3.1 Absolute Maximum Ratings

#### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ ) (1/2)

Parameter	Symbols	Conditions	Ratings	Unit
Supply voltage	$V_{DD}$		-0.5 to +6.5	V
	$EV_{DD0}, EV_{DD1}$	$EV_{DD0} = EV_{DD1}$	-0.5 to +6.5	V
	$EV_{SS0}, EV_{SS1}$	$EV_{SS0} = EV_{SS1}$	-0.5 to +0.3	V
REGC pin input voltage	$V_{IREGC}$	REGC	-0.3 to +2.8 and -0.3 to $V_{DD} + 0.3^{\text{Note 1}}$	V
Input voltage	$V_{I1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
	$V_{I2}$	P60 to P63 (N-ch open-drain)	-0.3 to +6.5	V
	$V_{I3}$	P20 to P27, P121 to P124, P137, P150 to P156, EXCLK, EXCLKS, RESET	-0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
Output voltage	$V_{O1}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
	$V_{O2}$	P20 to P27, P150 to P156	-0.3 to $V_{DD} + 0.3^{\text{Note 2}}$	V
Analog input voltage	$V_{AI1}$	ANI16 to ANI26	-0.3 to $EV_{DD0} + 0.3$ and -0.3 to $AV_{REF}(+) + 0.3^{\text{Notes 2, 3}}$	V
	$V_{AI2}$	ANIO to ANI14	-0.3 to $V_{DD} + 0.3$ and -0.3 to $AV_{REF}(+) + 0.3^{\text{Notes 2, 3}}$	V

- Notes 1.** Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu\text{F}$ ). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.
2. Must be 6.5 V or lower.
  3. Do not exceed  $AV_{REF}(+) + 0.3$  V in case of A/D conversion target pin.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

- Remarks**
1. Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.
  2.  $AV_{REF}(+)$  : + side reference voltage of the A/D converter.
  3.  $V_{ss}$  : Reference voltage

### 3.3.2 Supply current characteristics

#### (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4 \text{ V} \leq EV_{DD0} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = 0 \text{ V}$ ) (1/2)

Parameter	Symbol	Conditions					MIN.	TYP.	MAX.	Unit	
Supply current <small>Note 1</small>	$I_{DD1}$	Operating mode	HS (high-speed main) mode <small>Note 5</small>	$f_{IH} = 32 \text{ MHz}^{\text{Note 3}}$	Basic operation	$V_{DD} = 5.0 \text{ V}$		2.1		mA	
					Normal operation	$V_{DD} = 3.0 \text{ V}$		2.1		mA	
					$V_{DD} = 5.0 \text{ V}$		4.6	7.5		mA	
					$V_{DD} = 3.0 \text{ V}$		4.6	7.5		mA	
					$V_{DD} = 5.0 \text{ V}$		3.7	5.8		mA	
					$V_{DD} = 3.0 \text{ V}$		3.7	5.8		mA	
					$V_{DD} = 5.0 \text{ V}$		2.7	4.2		mA	
					$V_{DD} = 3.0 \text{ V}$		2.7	4.2		mA	
		HS (high-speed main) mode <small>Note 5</small>		$f_{MX} = 20 \text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 5.0 \text{ V}$	Normal operation	Square wave input		3.0	4.9	mA	
						Resonator connection		3.2	5.0	mA	
				$f_{MX} = 20 \text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0 \text{ V}$	Normal operation	Square wave input		3.0	4.9	mA	
						Resonator connection		3.2	5.0	mA	
				$f_{MX} = 10 \text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 5.0 \text{ V}$	Normal operation	Square wave input		1.9	2.9	mA	
						Resonator connection		1.9	2.9	mA	
				$f_{MX} = 10 \text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0 \text{ V}$	Normal operation	Square wave input		1.9	2.9	mA	
						Resonator connection		1.9	2.9	mA	
		Subsystem clock operation	$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 4</small> $T_A = -40^\circ\text{C}$	Normal operation	Square wave input		4.1	4.9		$\mu\text{A}$	
						Resonator connection		4.2	5.0	$\mu\text{A}$	
						Square wave input		4.1	4.9	$\mu\text{A}$	
						Resonator connection		4.2	5.0	$\mu\text{A}$	
						Square wave input		4.2	5.5	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 4</small> $T_A = +25^\circ\text{C}$	Normal operation		Resonator connection		4.3	5.6	$\mu\text{A}$	
						Square wave input		4.3	6.3	$\mu\text{A}$	
						Resonator connection		4.4	6.4	$\mu\text{A}$	
						Square wave input		4.6	7.7	$\mu\text{A}$	
						Resonator connection		4.7	7.8	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ <small>Note 4</small> $T_A = +50^\circ\text{C}$	Normal operation	Square wave input		6.9	19.7		$\mu\text{A}$	
						Resonator connection		7.0	19.8	$\mu\text{A}$	

(Notes and Remarks are listed on the next page.)

## (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products

 $(T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ ) (2/2)

Parameter	Symbol	Conditions				MIN.	TYP.	MAX.	Unit
Supply current Note 1	$I_{DD2}$ Note 2	HALT mode	HS (high-speed main) mode Note 7	$f_{IH} = 32 \text{ MHz}$ Note 4	$V_{DD} = 5.0 \text{ V}$		0.62	3.40	mA
					$V_{DD} = 3.0 \text{ V}$		0.62	3.40	mA
				$f_{IH} = 24 \text{ MHz}$ Note 4	$V_{DD} = 5.0 \text{ V}$		0.50	2.70	mA
					$V_{DD} = 3.0 \text{ V}$		0.50	2.70	mA
				$f_{IH} = 16 \text{ MHz}$ Note 4	$V_{DD} = 5.0 \text{ V}$		0.44	1.90	mA
					$V_{DD} = 3.0 \text{ V}$		0.44	1.90	mA
		HS (high-speed main) mode Note 7	$f_{MX} = 20 \text{ MHz}$ Note 3, $V_{DD} = 5.0 \text{ V}$	Square wave input		0.31	2.10	mA	
				Resonator connection		0.48	2.20	mA	
			$f_{MX} = 20 \text{ MHz}$ Note 3, $V_{DD} = 3.0 \text{ V}$	Square wave input		0.31	2.10	mA	
				Resonator connection		0.48	2.20	mA	
			$f_{MX} = 10 \text{ MHz}$ Note 3, $V_{DD} = 5.0 \text{ V}$	Square wave input		0.21	1.10	mA	
				Resonator connection		0.28	1.20	mA	
			$f_{MX} = 10 \text{ MHz}$ Note 3, $V_{DD} = 3.0 \text{ V}$	Square wave input		0.21	1.10	mA	
				Resonator connection		0.28	1.20	mA	
		Subsystem clock operation	$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = -40^\circ\text{C}$	Square wave input		0.28	0.61	$\mu\text{A}$	
				Resonator connection		0.47	0.80	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = +25^\circ\text{C}$	Square wave input		0.34	0.61	$\mu\text{A}$	
				Resonator connection		0.53	0.80	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = +50^\circ\text{C}$	Square wave input		0.41	2.30	$\mu\text{A}$	
				Resonator connection		0.60	2.49	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = +70^\circ\text{C}$	Square wave input		0.64	4.03	$\mu\text{A}$	
				Resonator connection		0.83	4.22	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = +85^\circ\text{C}$	Square wave input		1.09	8.04	$\mu\text{A}$	
				Resonator connection		1.28	8.23	$\mu\text{A}$	
			$f_{SUB} = 32.768 \text{ kHz}$ Note 5, $T_A = +105^\circ\text{C}$	Square wave input		5.50	41.00	$\mu\text{A}$	
				Resonator connection		5.50	41.00	$\mu\text{A}$	
	$I_{DD3}$ Note 6	STOP mode Note 8	$T_A = -40^\circ\text{C}$				0.19	0.52	$\mu\text{A}$
			$T_A = +25^\circ\text{C}$				0.25	0.52	$\mu\text{A}$
			$T_A = +50^\circ\text{C}$				0.32	2.21	$\mu\text{A}$
			$T_A = +70^\circ\text{C}$				0.55	3.94	$\mu\text{A}$
			$T_A = +85^\circ\text{C}$				1.00	7.95	$\mu\text{A}$
			$T_A = +105^\circ\text{C}$				5.00	40.00	$\mu\text{A}$

(Notes and Remarks are listed on the next page.)

5. The smaller maximum transfer rate derived by using  $f_{MCK}/12$  or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when  $2.4 \text{ V} \leq EV_{DD0} < 3.3 \text{ V}$  and  $1.6 \text{ V} \leq V_b \leq 2.0 \text{ V}$

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\} \times 3} \text{ [bps]}$$

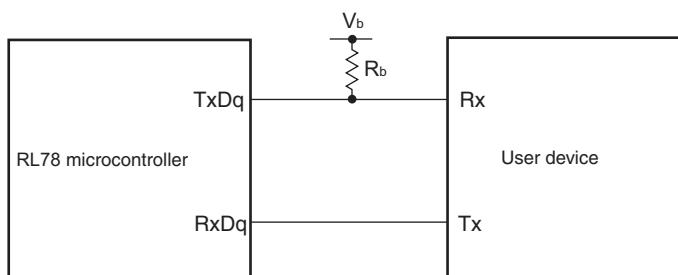
$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\}}{\left(\frac{1}{\text{Transfer rate}}\right) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

6. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 5 above to calculate the maximum transfer rate under conditions of the customer.

**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output ( $V_{DD}$  tolerance (for the 20- to 52-pin products)/ $EV_{DD}$  tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

#### UART mode connection diagram (during communication at different potential)



**(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (3/3)**

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>ss</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
Slp setup time (to SCKp↓) <sup>Note</sup>	t <sub>SIK1</sub>	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	88		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	88		ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	220		ns
Slp hold time (from SCKp↓) <sup>Note</sup>	t <sub>KSI1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	38		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	38		ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	38		ns
Delay time from SCKp↑ to SO <sub>p</sub> output <sup>Note</sup>	t <sub>KSO1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ		50	ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ		50	ns
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ		50	ns

**Note** When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

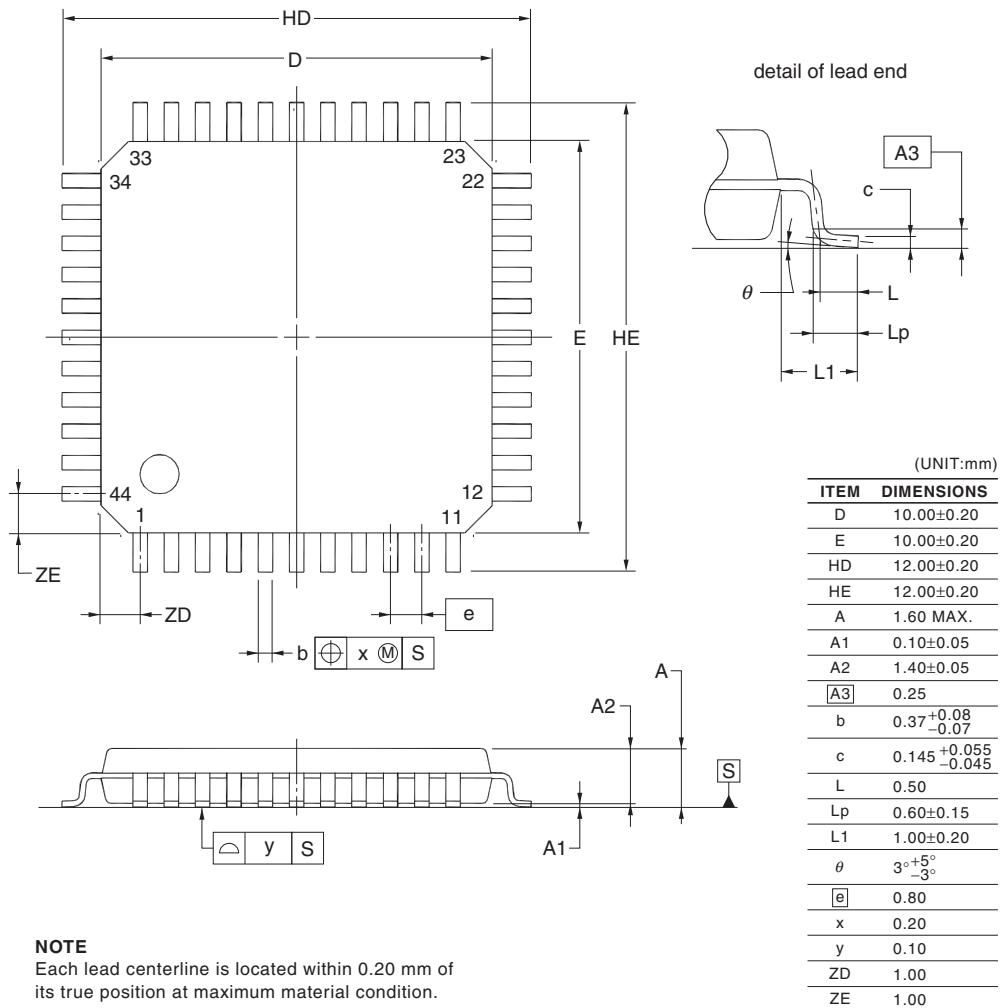
**Caution** Select the TTL input buffer for the Slp pin and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 20- to 52-pin products)/EV<sub>DD</sub> tolerance (for the 64- to 100-pin products)) mode for the SO<sub>p</sub> pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

#### 4.8 44-pin Products

R5F100FAAfp, R5F100FCAfp, R5F100FDAfp, R5F100FEAfp, R5F100FFAfp, R5F100FGAfp,  
 R5F100FHAfp, R5F100FJAfp, R5F100FKAfp, R5F100FLAfp  
 R5F101FAAfp, R5F101FCAfp, R5F101FDAfp, R5F101FEAfp, R5F101FFAfp, R5F101FGAfp,  
 R5F101FHAfp, R5F101FJAfp, R5F101FKAfp, R5F101FLAfp  
 R5F100FADfp, R5F100FCDFP, R5F100FDDfp, R5F100FEDfp, R5F100FFDFP, R5F100FGDFP,  
 R5F100FHDFP, R5F100FJDFP, R5F100FKDFP, R5F100FLDFP  
 R5F101FADfp, R5F101FCDFP, R5F101FDDfp, R5F101FEDfp, R5F101FFDFP, R5F101FGDFP,  
 R5F101FHDFP, R5F101FJDFP, R5F101FKDFP, R5F101FLDFP  
 R5F100FAGfp, R5F100FCGfp, R5F100FDGfp, R5F100FEGfp, R5F100FFGfp, R5F100FGGfp,  
 R5F100FHGfp, R5F100FJGfp

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP44-10x10-0.80	PLQP0044GC-A	P44GB-80-UES-2	0.36



Revision History		RL78/G13 Data Sheet	
Rev.	Date	Description	
		Page	Summary
1.00	Feb 29, 2012	-	First Edition issued
2.00	Oct 12, 2012	7	Figure 1-1. Part Number, Memory Size, and Package of RL78/G13: Pin count corrected.
		25	1.4 Pin Identification: Description of pins INTP0 to INTP11 corrected.
		40, 42, 44	1.6 Outline of Functions: Descriptions of Subsystem clock, Low-speed on-chip oscillator, and General-purpose register corrected.
		41, 43, 45	1.6 Outline of Functions: Lists of Descriptions changed.
		59, 63, 67	Descriptions of Note 8 in a table corrected.
		68	(4) Common to RL78/G13 all products: Descriptions of Notes corrected.
		69	2.4 AC Characteristics: Symbol of external system clock frequency corrected.
		96 to 98	2.6.1 A/D converter characteristics: Notes of overall error corrected.
		100	2.6.2 Temperature sensor characteristics: Parameter name corrected.
		104	2.8 Flash Memory Programming Characteristics: Incorrect descriptions corrected.
		116	3.10 52-pin products: Package drawings of 52-pin products corrected.
		120	3.12 80-pin products: Package drawings of 80-pin products corrected.
3.00	Aug 02, 2013	1	Modification of 1.1 Features
		3	Modification of 1.2 List of Part Numbers
		4 to 15	Modification of Table 1-1. List of Ordering Part Numbers, note, and caution
		16 to 32	Modification of package type in 1.3.1 to 1.3.14
		33	Modification of description in 1.4 Pin Identification
		48, 50, 52	Modification of caution, table, and note in 1.6 Outline of Functions
		55	Modification of description in table of Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )
		57	Modification of table, note, caution, and remark in 2.2.1 X1, XT1 oscillator characteristics
		57	Modification of table in 2.2.2 On-chip oscillator characteristics
		58	Modification of note 3 of table (1/5) in 2.3.1 Pin characteristics
		59	Modification of note 3 of table (2/5) in 2.3.1 Pin characteristics
		63	Modification of table in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products
		64	Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products
		65	Modification of table in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products
		66	Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products
		68	Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products
		70	Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products
		72	Modification of notes 1 and 4 in (3) Flash ROM: 384 to 512 KB of 44- to 100-pin products
		74	Modification of notes 1, 5, and 6 in (3) Flash ROM: 384 to 512 KB of 44- to 100-pin products
		75	Modification of (4) Peripheral Functions (Common to all products)
		77	Modification of table in 2.4 AC Characteristics
		78, 79	Addition of Minimum Instruction Execution Time during Main System Clock Operation
		80	Modification of figures of AC Timing Test Points and External System Clock Timing